			07-21-20	03		
Form-PTO-1595 TRA 1-31-92 1025025			78	ORDATION Atty. Docket: 03500		
	To the Direct	tor, U.S. Patent and 1	rademark Office: Please	e recora me ana	ched original documents or copy there	eof.
Y	Name of conveying parties: YUKIHIRO HAYAKAWA, KEI FUJITA and 7.9.03 MINEO SHIMOTSUSA Additional name(s) of conveying party(ies) attached?				l address of receiving party(ies): DN KABUSHIKI KAISHA	88 88 100
А				Foreign Address: <u>3-30-02 Shimomaruko, Ohta-ku</u>		
	Vature of conveya X Assignment Security Agree Other	🛄 Mer	nge of Name		Tokyo, Japan           dress:	Р 21906
E	Execution June 30, 2003			Additional name(s) & address(es) attached? Yes x No		
	<ul> <li>Application number(s) or patent number(s):</li> <li>If this document is being filed together with a new application, the execution date of the application is:</li> </ul>					
A	<ul> <li>A. Patent Applica</li> <li>Filing Date: J</li> <li>Additional number</li> <li>Additional number</li> </ul>	• • • • • • • • • • • • • • • • • • • •	t Assigned		of Invention: SEMICONDUCTOR DI TING DEVICE USING THE SAME	EVICE AND
	Name and address of party to whom correspondence concerning document should be mailed:			6. Number of	of applications and patents involved:	
N	Jame:	Fitzpatrick, Cella, H	arner & Scinto		One	
		30 Rockefeller Plaza		7. Total fee	(37 CFR 3.41): \$40.	00
	· · ·	New York, New York	rk 10112-3801	X Enclos	sed rized to be charged to deposit account	
т	elephone No.:	(212) 218-2100		8. Deposit a	ccount number (for deficiency or exce	ss)
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	tatement and sign to the best of my the copy of the or	/	the foregoing information	on is true and th	ne attached is the original document or	is a
I er	nard P Diana (I	Reg. No. 29,296)	~ 07	Dia.	Lub. 0 2002	
	Name of Person		Signa	iture	<u>July 8, 2003</u> Date	
			-		g cover sheet, attachments, and docum	ents: 2

NY\_MAIN 361265v1

### ASSIGNMENT OF PATENT RIGHTS FOR THE UNITED STATES

FOR VALUE RECEIVED, WE, Yukihiro Hayakawa, Kei Fujita and Mineo Shimotsusa

hereby sell, assign, transfer and convey unto CANON KABUSHIKI KAISHA

#### a corporation of **JAPAN**

having a place of business at

## 3-30-2, Shimomaruko, Ohta-ku, Tokyo, Japan

its successors, assigns and legal representatives (hereinafter called the "Assignee"), the entire right, title and interest, for the United States, in and to certain inventions relating to

### SEMICONDUCTOR DEVICE AND LIQUID JETTING DEVICE USING THE SAME

and described in an application for Letters Patent of the United States executed by each of us, respectively, on the date indicated below and in and to said application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted, thereon, and all reissues and extensions thereof; and we hereby authorize and request the Commissioner for Patents and Trademarks of the United States to issue all Letters Patent upon said inventions to the Assignee or to such nominees as it may designate.

AND we authorize and empower the said Assignee or nominees to invoke and claim for any application for patent or other form of protection for said inventions, the benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it, and to invoke and claim such right of priority without further written or oral authorization from us.

AND we hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file or like document which may be required in the United States for any purpose and more particularly in proof of the right of said Assignee or nominees to claim the aforesaid benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it.

AND we hereby covenant that we have the full right to convey the entire right, title and interest herein assigned and that we have not executed and will not execute any agreement in conflict herewith.

AND we hereby covenant and agree that we will communicate to said Assignee or nominees all facts known to us pertaining to said inventions, and testify in all legal proceedings, sign all lawful papers, execute all continuing and reissue applications, make all rightful oaths and declarations and in general perform all lawful acts necessary or proper to aid said Assignee or nominees in obtaining, maintaining and enforcing all lawful patent protection for said inventions in the United States.

By: <u>Jukihiro Hayakawa</u> By: <u>Vukihiro Hayakawa</u> By: <u>Kei Fujita</u> By: <u>Minea Shimatawa</u> By: <u>Mineo Shimatawa</u> Date: <u>June 30, 2003</u> Date: <u>June 30, 2003</u>

Date:

By:	Date:
By:	 Date:

PATENT REEL: 014273 FRAME: 0692

# **RECORDED: 07/09/2003**

By:\_\_\_